

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The V_S and V_{SS} offset ratings are tested with all supplies biased at 15V differential. Typical ratings at other bias conditions are shown in Figures 36 and 37.

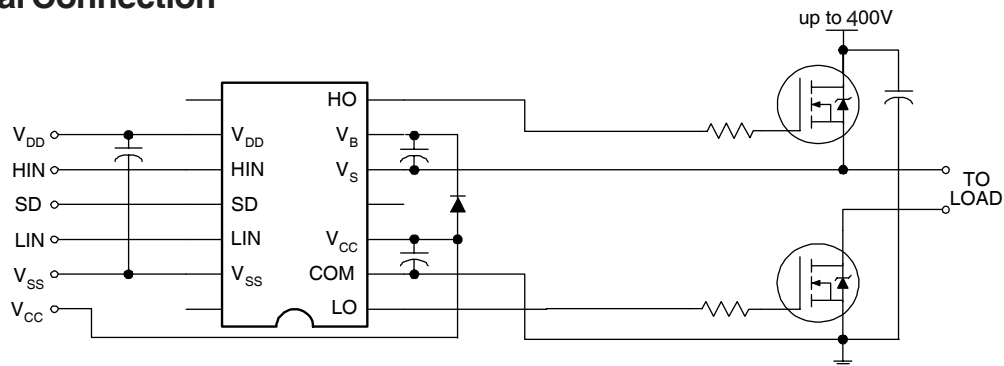
Symbol	Parameter	Min.	Max.	Units
V_B	High Side Floating Supply Absolute Voltage	$V_S + 10$	$V_S + 20$	V
V_S	High Side Floating Supply Offset Voltage	-4	400	
V_{HO}	High Side Output Voltage	V_S	V_B	
V_{CC}	Low Side Fixed Supply Voltage	10	20	
V_{LO}	Low Side Output Voltage	0	V_{CC}	
V_{DD}	Logic Supply Voltage	$V_{SS} + 5$	$V_{SS} + 20$	
V_{SS}	Logic Supply Offset Voltage	-5	5	
V_{IN}	Logic Input Voltage (HIN, LIN & SD)	V_{SS}	V_{DD}	

Dynamic Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS} , V_{DD}) = 15V, C_L = 1000 pF, T_A = 25°C and V_{SS} = COM unless otherwise specified. The dynamic electrical characteristics are measured using the test circuit shown in Figure 3.

Symbol	Parameter	$T_j = 25^\circ\text{C}$			$T_j = -55 \text{ to } 125^\circ\text{C}$		Units	Test Conditions
		Min	Typ.	Max.	Min.	Max		
t_{on}	Turn-On Propagation Delay	—	120	150	—	260	nS	$V_S = 0V$
t_{off}	Turn-Off Propagation Delay	—	94	125	—	220		$V_S = 400V$
t_{sd}	Shutdown Propagation Delay	—	110	140	—	235		$V_S = 400V$
t_r	Turn-On Rise Time	—	25	35	—	50		$C_L = 1000\text{pF}$
t_f	Turn-Off Fall Time	—	17	25	—	40		$C_L = 1000\text{pF}$
Mt	Delay Matching, HS & LS Turn-On/Off	—	—	20	—	—		$ Ht_{on}-Lt_{on} / Ht_{off}-Lt_{off} $

Typical Connection



Static Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS} , V_{DD}) = 15V, T_A = 25°C and V_{SS} = COM unless otherwise specified. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to V_{SS} and are applicable to all three logic input leads: HIN, LIN and SD. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Parameter	$T_j = 25^\circ\text{C}$			$T_j = -55 \text{ to } 125^\circ\text{C}$		Units	Test Conditions
		Min	Typ.	Max.	Min.	Max.		
V_{IH}	Logic "1" Input Voltage	9.5	—	—	10	—	V	$V_{DD} = 15\text{V}$
V_{IL}	Logic "0" Input Voltage	—	—	6	—	5.7		$V_{DD} = 15\text{V}$
V_{OH}	High Level Output Voltage, $V_{BIAS} - V_O$	—	0.7	1.2	—	1.5		$V_{IN} = V_{IH}$, $I_O = 0\text{A}$
V_{OL}	Low Level Output Voltage, V_O	—	—	0.1	—	0.1		$V_{IN} = V_{IL}$, $I_O = 0\text{A}$
I_{LK}	Offset Supply Leakage Current	—	—	50	—	250	μA	$V_B = V_S = 400\text{V}$
I_{QBS}	Quiescent V_{BS} Supply Current	—	125	230	—	500		$V_{IN} = V_{IH} \text{ or } V_{IL}$
I_{QCC}	Quiescent V_{CC} Supply Current	—	180	340	—	600		$V_{IN} = V_{IH} \text{ or } V_{IL}$
I_{QDD}	Quiescent V_{DD} Supply Current	—	5	30	—	60		$V_{IN} = V_{IH} \text{ or } V_{IL}$
I_{IN+}	Logic "1" Input Bias Current	—	15	40	—	70		$V_{IN} = 15\text{V}$
I_{IN-}	Logic "0" Input Bias Current	—	—	1	—	10		$V_{IN} = 0\text{V}$
V_{BSUV+}	V_{BS} Supply Undervoltage Positive Going Threshold	7.5	8.7	9.7	—	—	V	
V_{BSUV-}	V_{BS} Supply Undervoltage Negative Going Threshold	7.0	8.3	9.4	—	—		
V_{CCUV+}	V_{CC} Supply Undervoltage Positive Going Threshold	7.4	8.6	9.6	—	—		
V_{CCUV-}	V_{CC} Supply Undervoltage Negative Going Threshold	7.0	8.2	9.4	—	—		
I_{O+}	Output High Short Circuit Pulsed Current	2	—	—	—	—	A	$V_{OUT} = 0\text{V}$, $V_{IN} = 15\text{V}$ $PW \leq 10\mu\text{s}$
I_{O-}	Output Low Short Circuit Pulsed Current	2	—	—	—	—		$V_{OUT} = 15\text{V}$, $V_{IN} = 0\text{V}$ $PW \leq 10\mu\text{s}$

IR2110E4

International
IR Rectifier

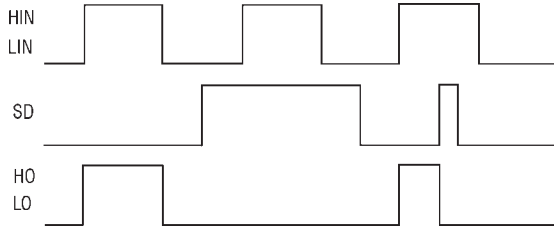


Figure 1. Input/Output Timing Diagram

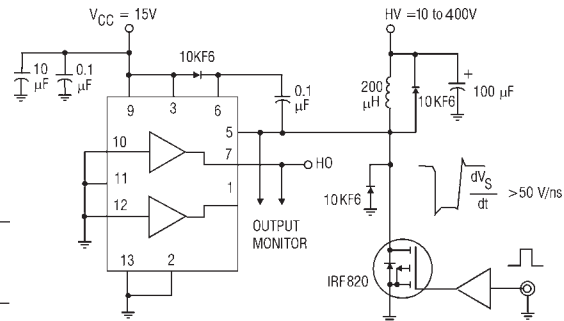


Figure 2. Floating Supply Voltage Transient Test Circuit

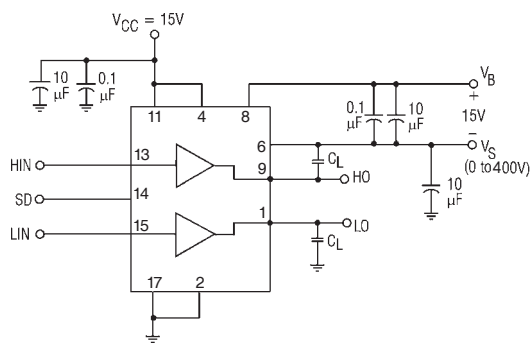


Figure 3. Switching Time Test Circuit

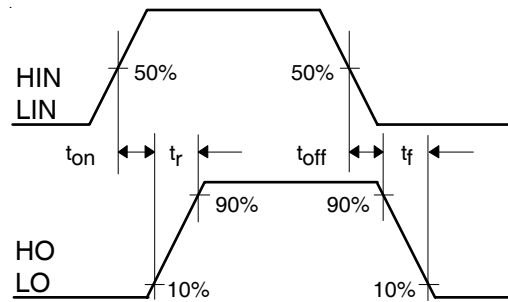


Figure 4. Switching Time Waveform Definition

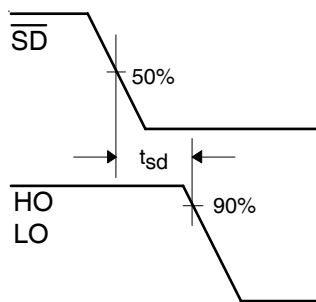


Figure 3. Shutdown Waveform Definitions

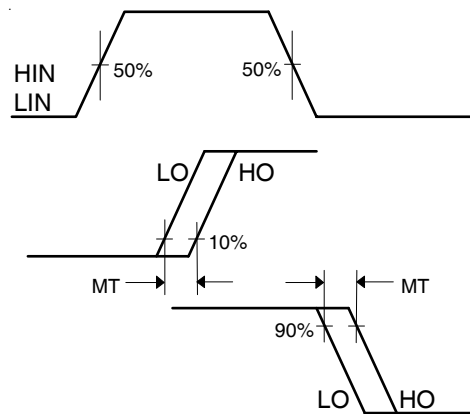


Figure 6. Delay Matching Waveform Definitions

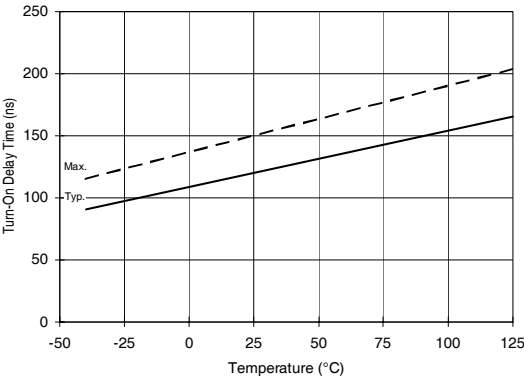


Figure 7A. Turn-On Time vs. Temperature

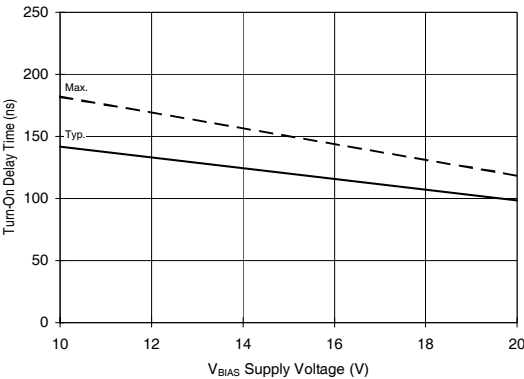


Figure 7B. Turn-On Time vs. Voltage

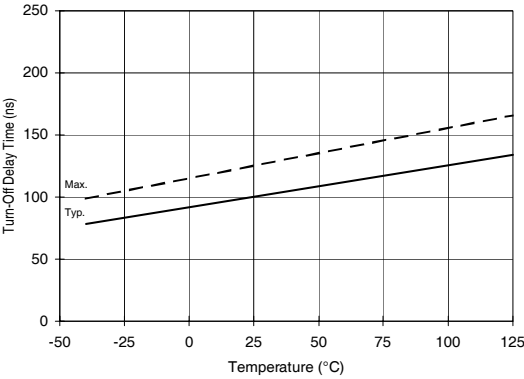


Figure 8A. Turn-Off Time vs. Temperature

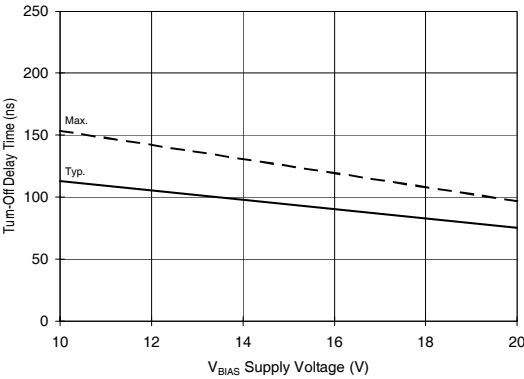


Figure 8B. Turn-Off Time vs. Voltage

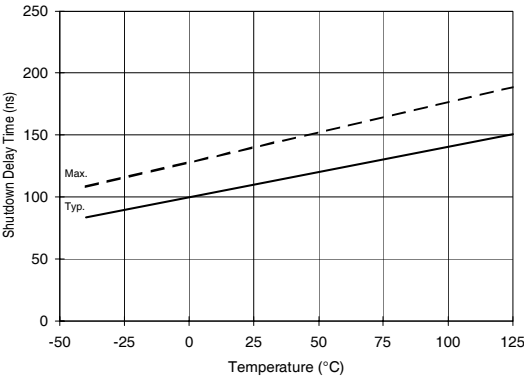


Figure 9A. Shutdown Time vs. Temperature

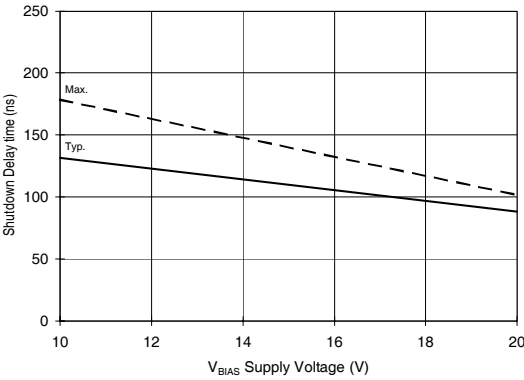


Figure 9B. Shutdown Time vs. Voltage

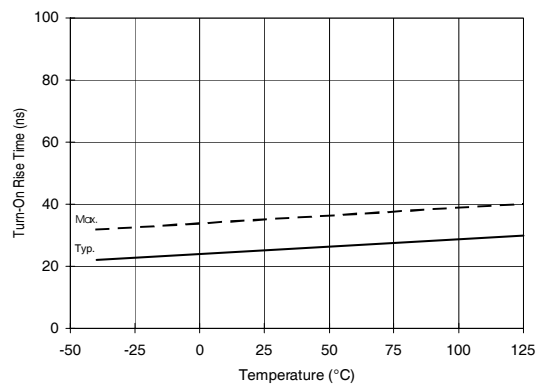


Figure 10A. Turn-On Rise Time vs. Temperature

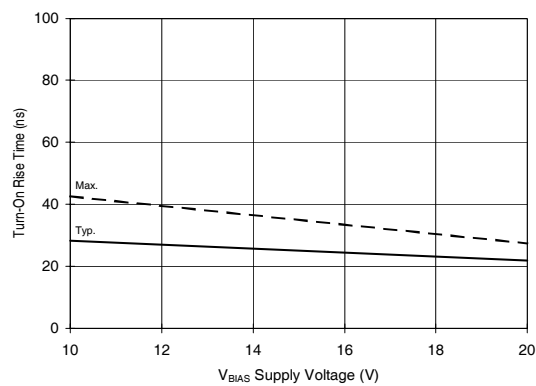


Figure 10B. Turn-On Rise Time vs. Voltage

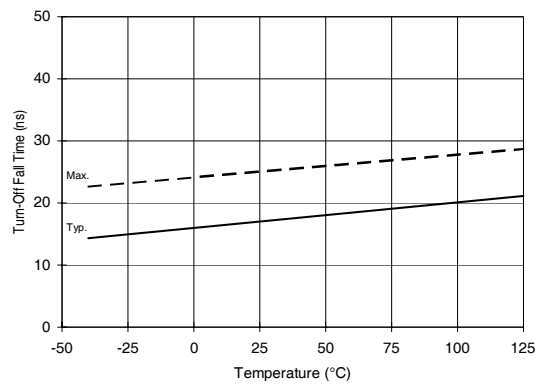


Figure 11A. Turn-Off Fall Time vs. Temperature

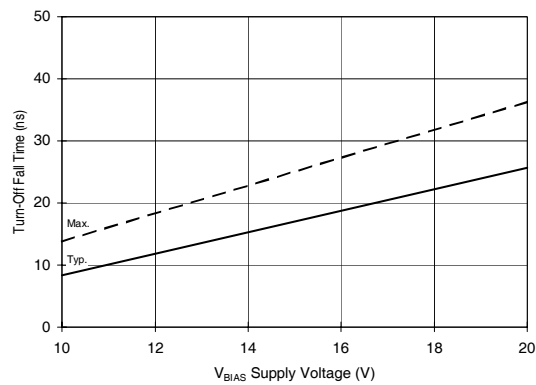


Figure 11B. Turn-Off Fall Time vs. Voltage

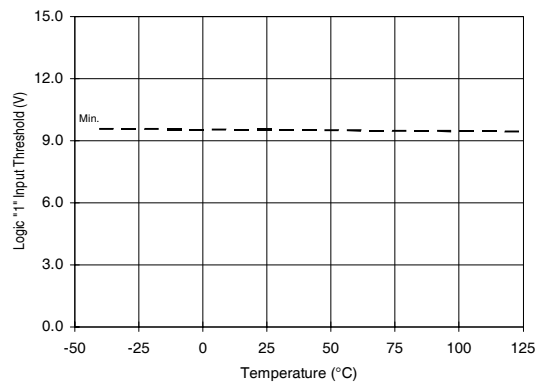


Figure 12A. Logic "1" Input Threshold vs. Temperature

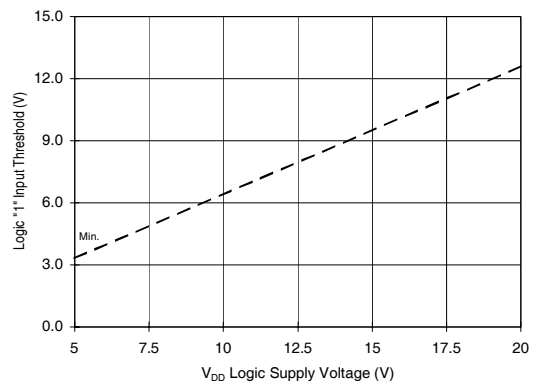


Figure 12B. Logic "1" Input Threshold vs. Voltage

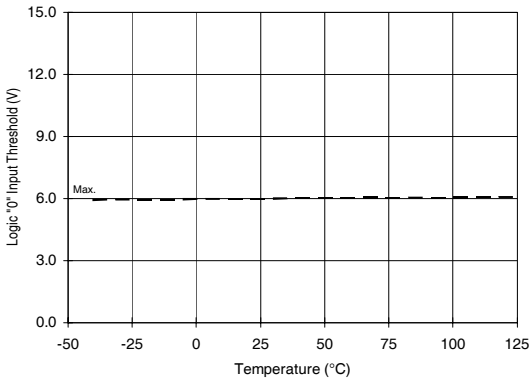


Figure 13A. Logic "0" Input Threshold vs. Temperature

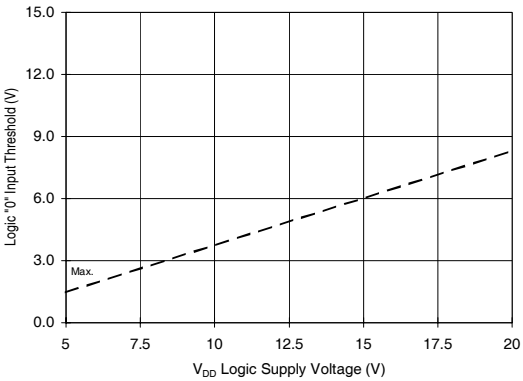


Figure 13B. Logic "0" Input Threshold vs. Voltage

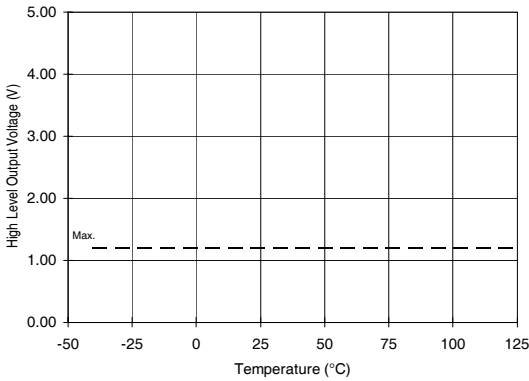


Figure 14A. High Level Output vs. Temperature

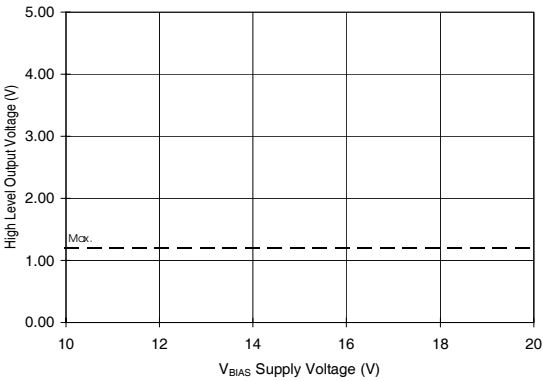


Figure 14B. High Level Output vs. Voltage

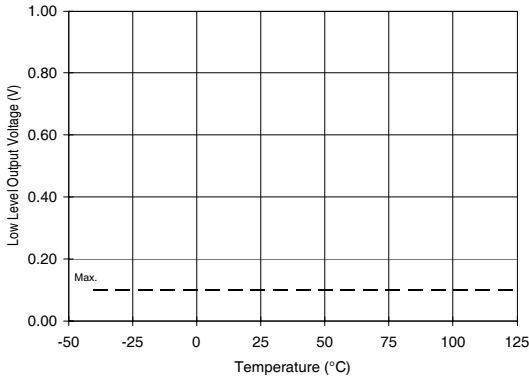


Figure 15A. Low Level Output vs. Temperature

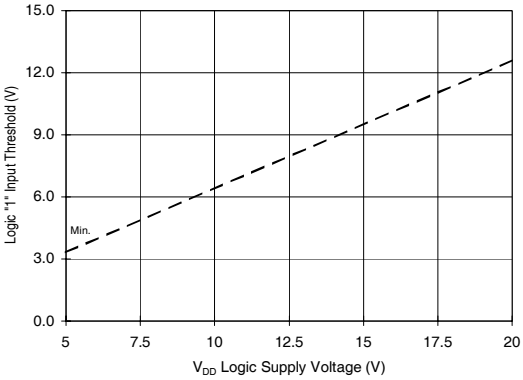


Figure 15B. Low Level Output vs. Voltage

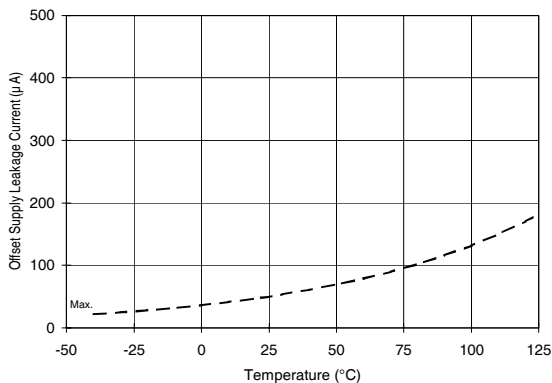


Figure 16A. Offset Supply Current vs. Temperature

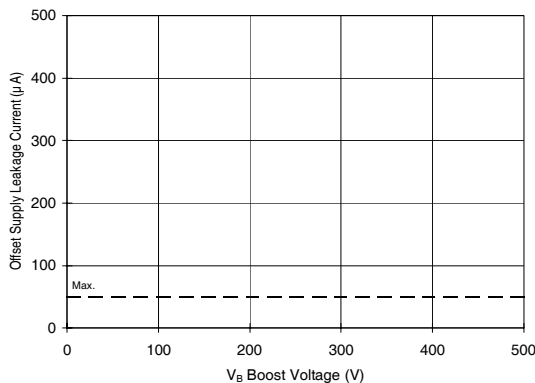


Figure 16B. Offset Supply Current vs. Voltage

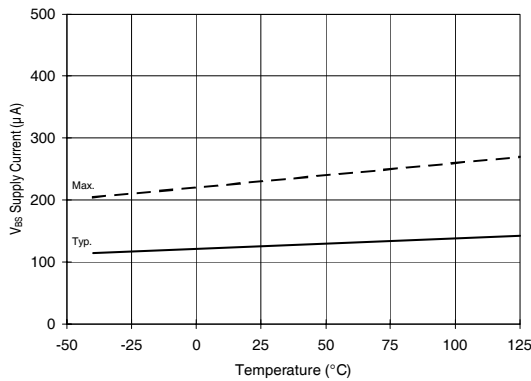


Figure 17A. V_{BS} Supply Current vs. Temperature

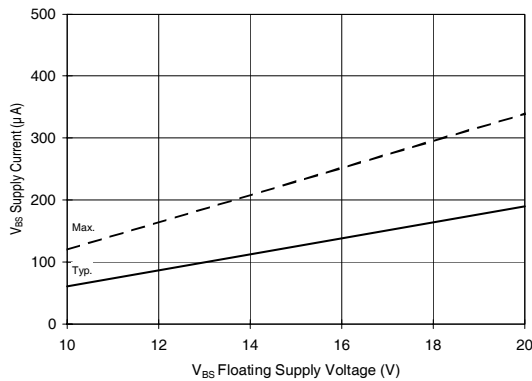


Figure 17B. V_{BS} Supply Current vs. Voltage

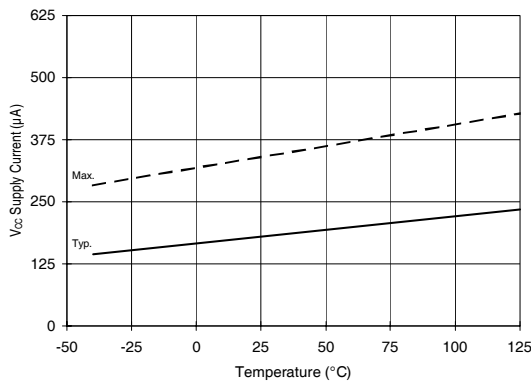


Figure 18A. V_{CC} Supply Current vs. Temperature

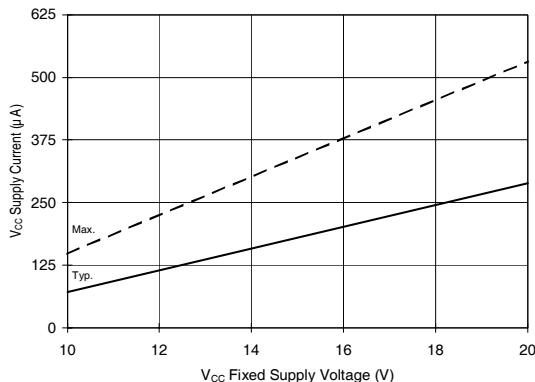


Figure 18B. V_{CC} Supply Current vs. Voltage

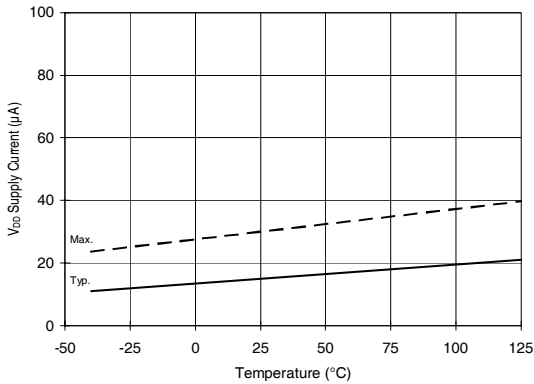


Figure 19A. V_{DD} Supply Current vs. Temperature

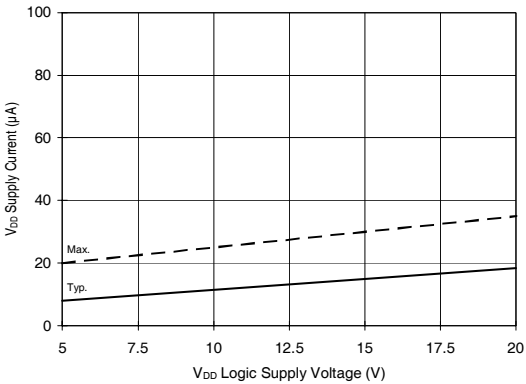


Figure 19B. V_{DD} Supply Current vs. Voltage

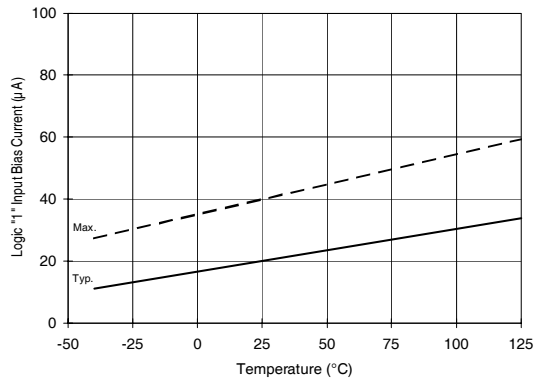


Figure 20A. Logic "1" Input Current vs. Temperature

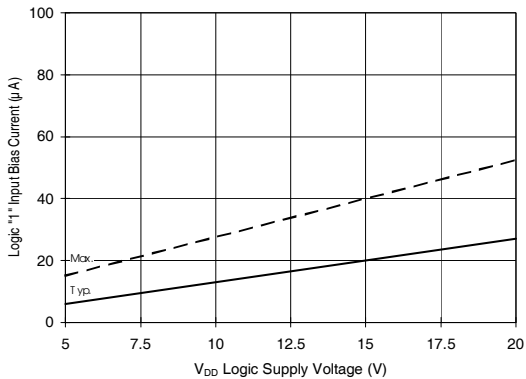


Figure 20B. Logic "1" Input Current vs. Voltage

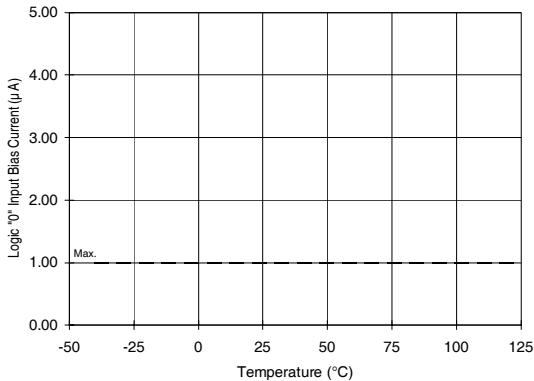


Figure 21A. Logic "0" Input Current vs. Temperature

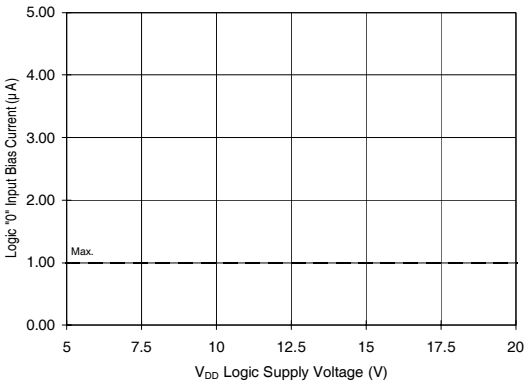


Figure 21B. Logic "0" Input Current vs. Voltage

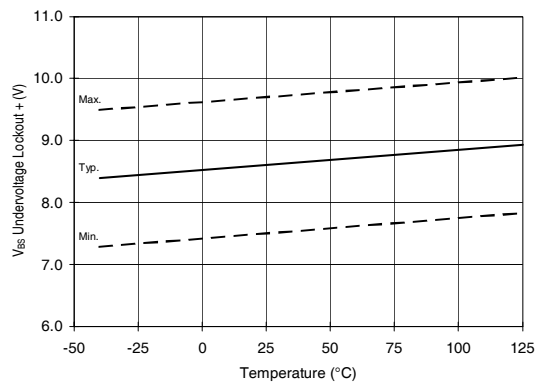


Figure 22. V_{BS} Undervoltage (+) vs. Temperature

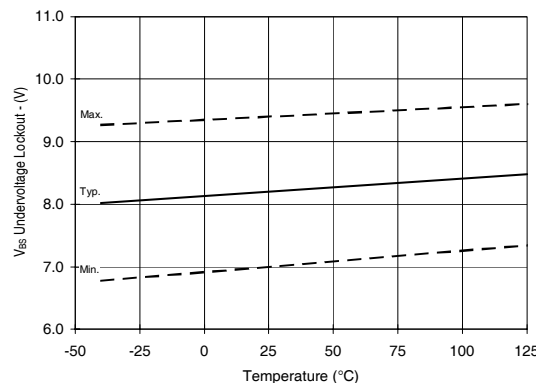


Figure 23. V_{BS} Undervoltage (-) vs. Temperature

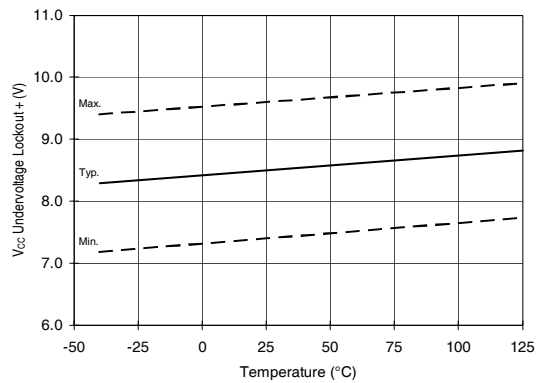


Figure 24. V_{CC} Undervoltage (+) vs. Temperature

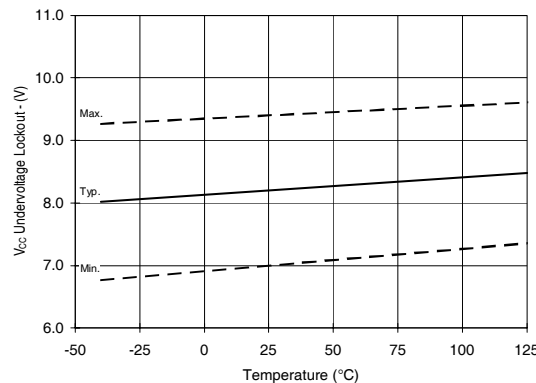


Figure 25. V_{CC} Undervoltage (-) vs. Temperature

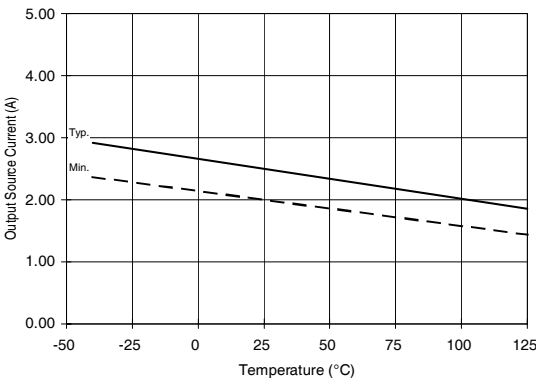


Figure 26A. Output Source Current vs. Temperature

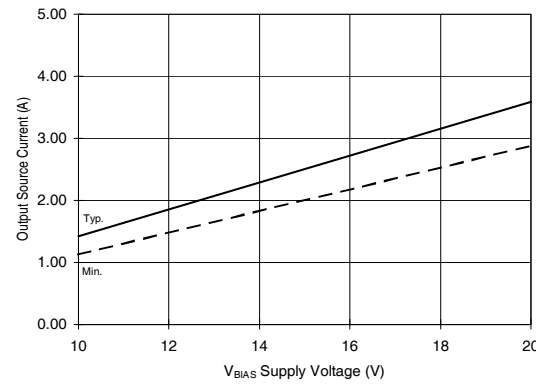


Figure 26B. Output Source Current vs. Voltage

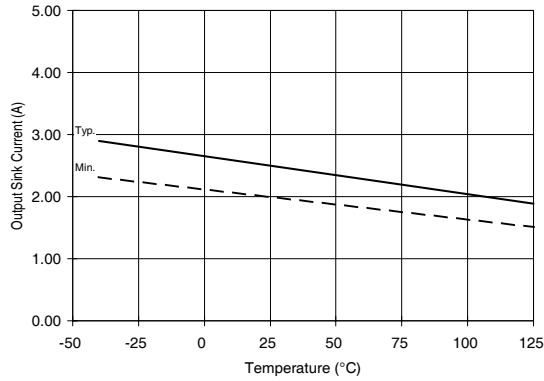


Figure 27A. Output Sink Current vs. Temperature

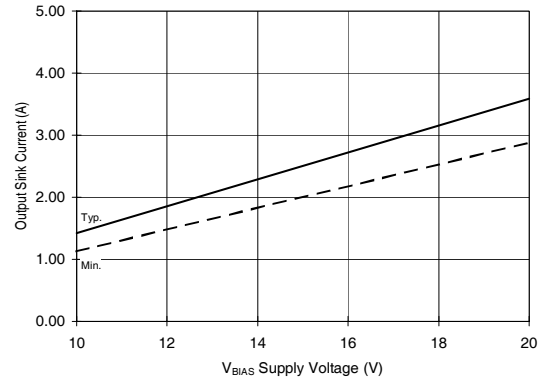


Figure 27B. Output Sink Current vs. Voltage

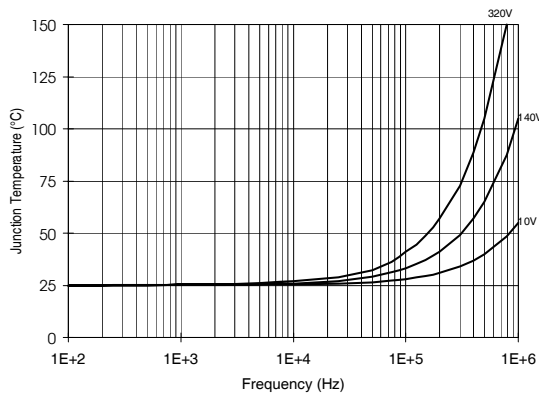


Figure 28. IR2110 T_J vs. Frequency (IRFBC20)
 $R_{GATE} = 33W$, $V_{CC} = 15V$

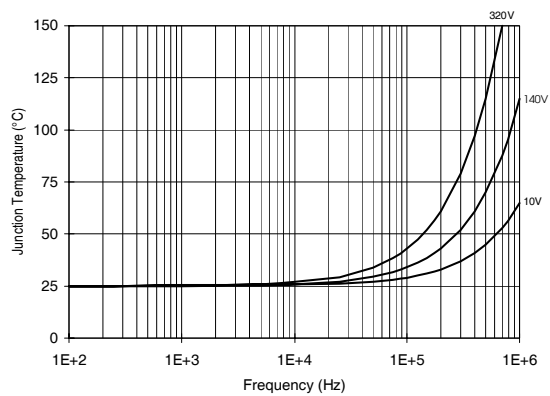


Figure 29. IR2110 T_J vs. Frequency (IRFBC30)
 $R_{GATE} = 22W$, $V_{CC} = 15V$

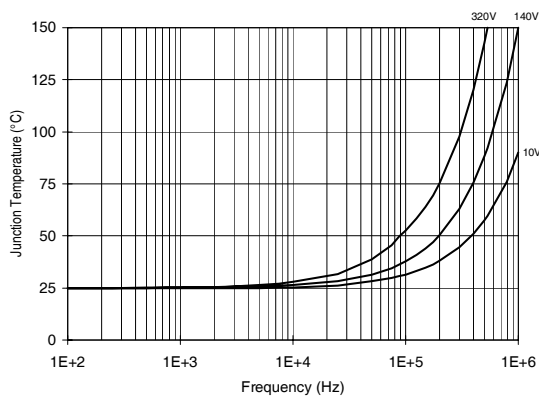


Figure 30. IR2110 T_J vs. Frequency (IRFBC40)
 $R_{GATE} = 15W$, $V_{CC} = 15V$

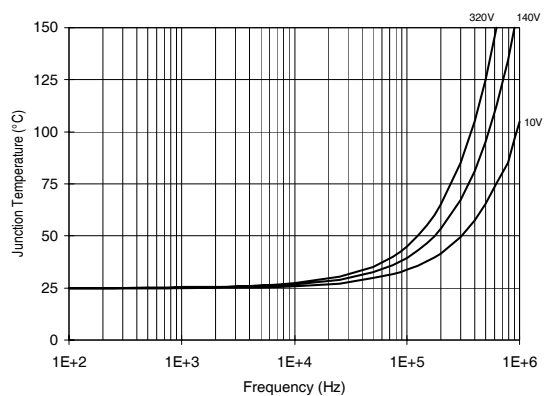


Figure 31. IR2110 T_J vs. Frequency (IRFPE50)
 $R_{GATE} = 10W$, $V_{CC} = 15V$

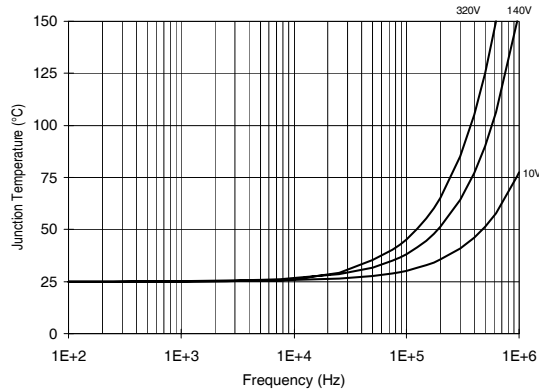


Figure 32. IR2110S T_J vs. Frequency (IRFBC20)
 $R_{GATE} = 33W$, $V_{CC} = 15V$

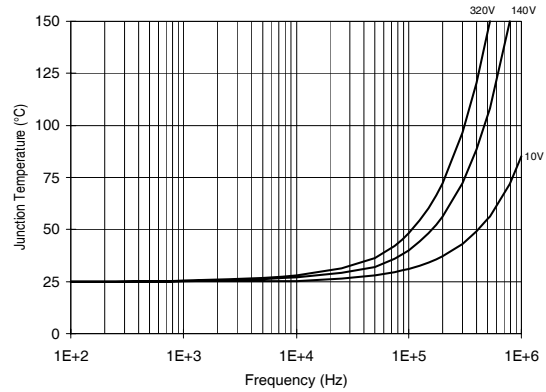


Figure 33. IR2110S T_J vs. Frequency (IRFBC30)
 $R_{GATE} = 22W$, $V_{CC} = 15V$

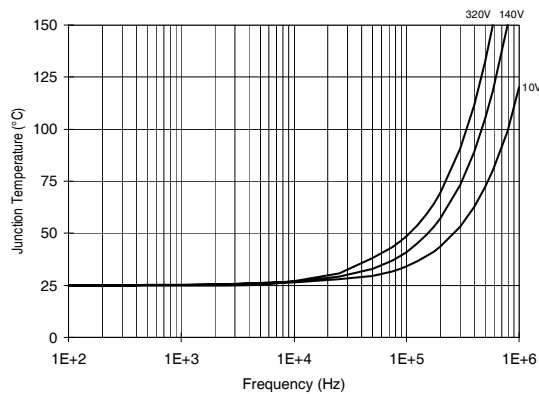


Figure 34. IR2110S T_J vs. Frequency (IRFBC40)
 $R_{GATE} = 15W$, $V_{CC} = 15V$

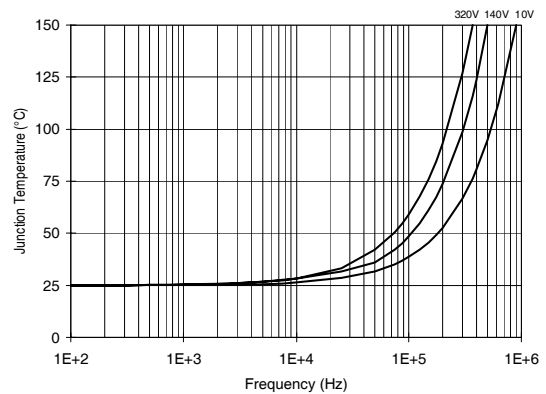


Figure 35. IR2110S T_J vs. Frequency (IRFPE50)
 $R_{GATE} = 10W$, $V_{CC} = 15V$

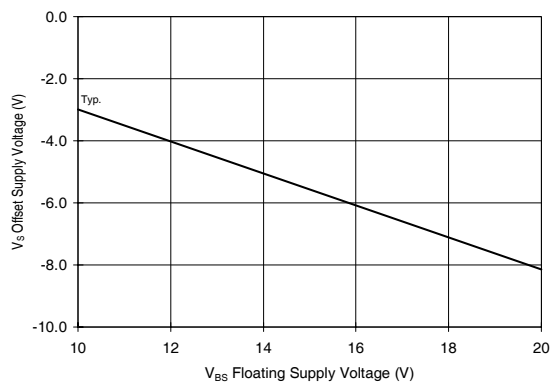


Figure 36. Maximum V_S Negative Offset vs.
 V_{BS} Supply Voltage

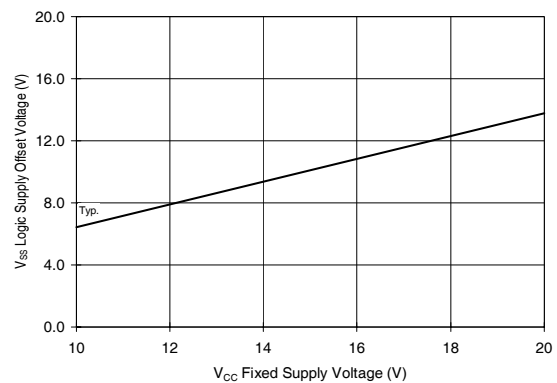
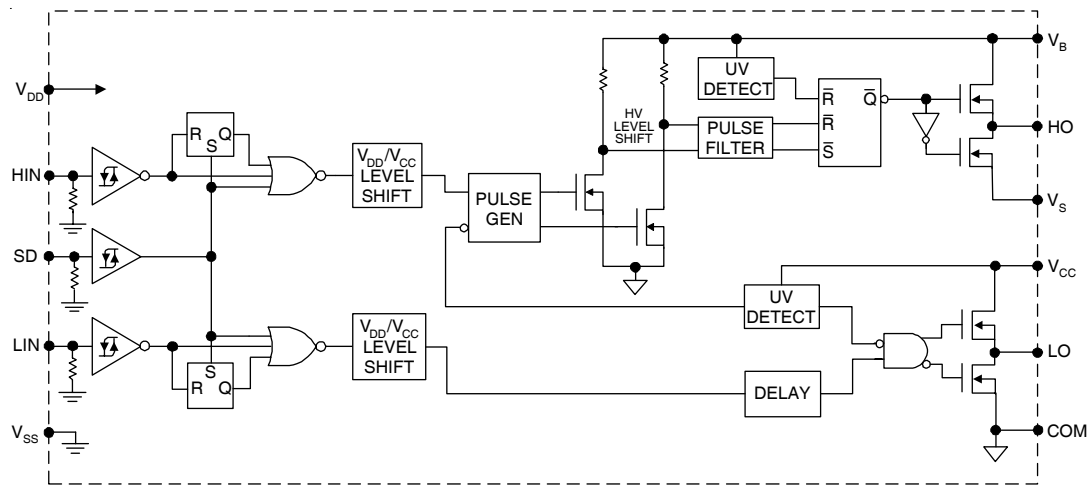


Figure 37. Maximum V_{SS} Positive Offset vs.
 V_{CC} Supply Voltage

Functional Block Diagram



Lead Definitions

Lead	
Symbol	Description
V _{DD}	Logic supply
HIN	Logic input for high side gate driver output (HO), in phase
SD	Logic input for shutdown
LIN	Logic input for low side gate driver output (LO), in phase
V _{SS}	Logic ground
V _B	High side floating supply
HO	High side gate drive output
V _S	High side floating supply return
V _{CC}	Low side supply
LO	Low side gate drive output
COM	Low side return

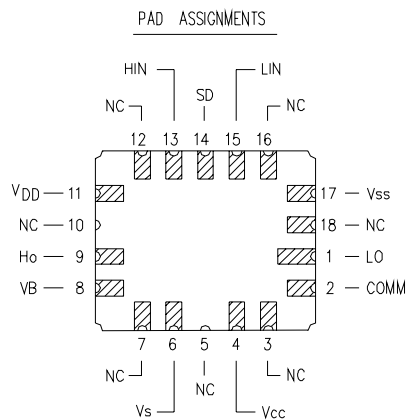
International
IOR Rectifier

Technical drawing of a mechanical part showing three views: TOP VIEW, BOTTOM VIEW, and a side view (labeled -C-).

TOP VIEW: Shows a rectangular part with a central hole. Dimensions include 9.14 [.360] and 8.77 [.345] for the top edge, and 7.49 [.295] and 7.12 [.280] for the left edge. Section lines A-A and B-B are indicated.

BOTTOM VIEW: Shows the underside of the part. Dimensions include 1.27 [.050] for the top edge, 0.635 [.025] for the left edge, and 1.21 [.048] and 0.82 [.032] for the bottom edge. Section lines 14X, 16X, and 18 are indicated. A feature callout box contains the following information: 0.76 [.030], 0.51 [.020], 0.25 [.010], M, C, B, S, A, S.

Side View (-C-): Shows the profile of the part. Dimensions include 3.22 [.127] and 1.96 [.077] for the top edge, and 0.08 [.003] for the bottom edge. A feature callout box contains the following information: 0.08 [.003].



1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

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IOR Rectifier

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